

### Thyristor Modules

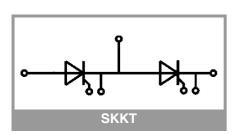
### SKKT 107/16 E

#### Features\*

- Heat transfer through aluminium oxide ceramic insulated metal baseplate
- UL recognized, file no. E63532

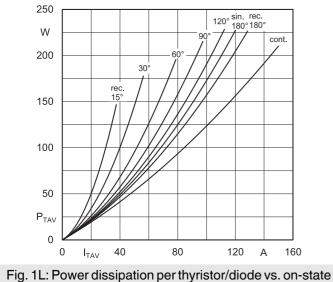
### **Typical Applications**

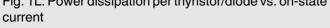
- DC motor control (e. g. for machine tools)
- AC motor soft starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

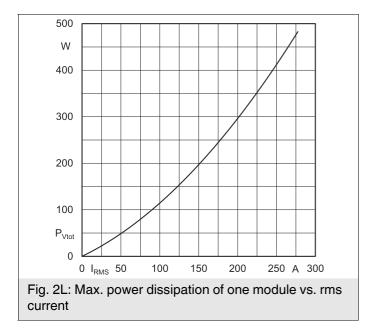


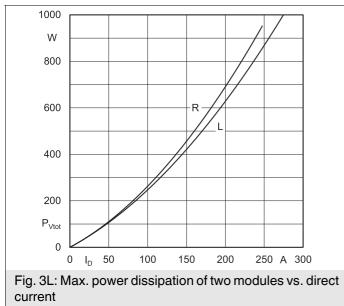
Absolute	e Maximum Rating	S				
Symbol	Conditions			Values		Unit
Chip						
I <sub>T(AV)</sub>	sin. 180°	T <sub>c</sub> = 85 °C	1	119		Α
,	T <sub>j</sub> = 130 °C	T <sub>c</sub> = 100 °C		91		Α
I <sub>TSM</sub>	40	T <sub>j</sub> = 25 °C	2250			Α
1011	_ 10 ms	T <sub>i</sub> = 130 °C	1900			Α
i <sup>2</sup> t	10	T <sub>j</sub> = 25 °C	25313			A <sup>2</sup> s
	10 ms	T <sub>j</sub> = 130 °C	18050			A <sup>2</sup> s
V <sub>RSM</sub>	T <sub>j</sub> = 25 °C	1700			V	
V <sub>RRM</sub>	T <sub>j</sub> = 25 °C	1600			V	
V <sub>DRM</sub>	T <sub>j</sub> = 25 °C	1600			V	
(di/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C	140			A/µs	
(dv/dt) <sub>cr</sub>	T <sub>j</sub> = 130 °C	1000			V/µs	
Tj		-40 130			°C	
Module						
T <sub>stg</sub>		-40 125			°C	
Visol	50.11	1 min	3000			V
	a.c.; 50 Hz; r.m.s.	1 s		3600		
<u>.</u>						
Characte	eristics					1
Symbol	Conditions		min.	typ.	max.	Unit
Chip						
VT	$T_j = 25 \ ^{\circ}C, I_T = 300$		1.6	1.75	V	
V <sub>T(TO)</sub>	T <sub>j</sub> = 130 °C		0.8	0.90	V	
r <sub>T</sub>	T <sub>j</sub> = 130 °C		2.80	3.35	mΩ	
I <sub>DD</sub> ;I <sub>RD</sub>	$T_j = 130 \ ^{\circ}C, V_{DD} =$			20	mA	
t <sub>gd</sub>	$T_j = 25 \ ^{\circ}C, I_G = 1 \ A$		1		μs	
t <sub>gr</sub>	$V_{D} = 0.67 * V_{DRM}$		2		μs	
tq	T <sub>j</sub> = 130 °C		200		μs	
I <sub>H</sub>	T <sub>j</sub> = 25 °C			150	250	mA
I <sub>L</sub>	$T_j = 25 ^{\circ}C, R_G = 33$		300	600	mA	
V <sub>GT</sub>	T <sub>j</sub> = 25 °C, d.c.		2.5			V
I <sub>GT</sub>	$T_{j} = 25 ^{\circ}C,  d.c.$		100			mA
V <sub>GD</sub>	T <sub>j</sub> = 130 °C, d.c.				0.25	V
I <sub>GD</sub>	$T_j = 130 \ ^{\circ}C, \ d.c.$	1			4	mA
R <sub>th(j-c)</sub>	continuous DC	per chip			0.15	K/W
		per module			0.075	K/W
R <sub>th(j-c)</sub>	sin. 180°	per chip			0.2	K/W
		per module			0.1	K/W
R <sub>th(j-c)</sub>	rec. 120°	per chip			0.21	K/W
		per module			0.105	K/W
Module						
$R_{th(c-s)}$	chip		1	0.09		K/W
	module		0.05		K/W	
N.4	to be atainly MC		4.05		F 75	

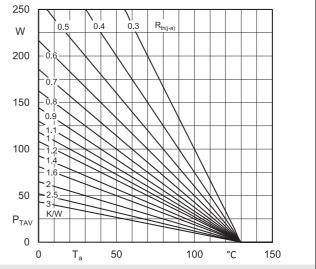
		permodule			0.105	r\/ VV
Module						
R <sub>th(c-s)</sub>	chip			0.09		K/W
	module			0.05		K/W
Ms	to heatsink M5		4.25		5.75	Nm
Mt	to terminals M5		2.55		3.45	Nm
а					5 * 9.81	m/s²
w				75		g



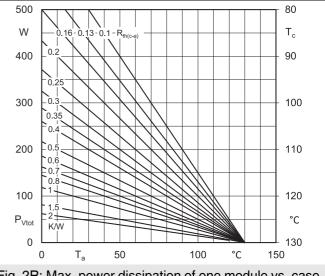




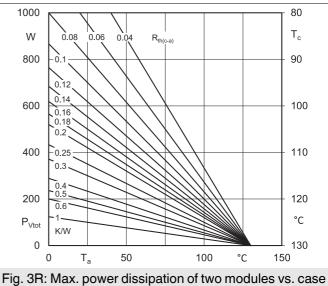




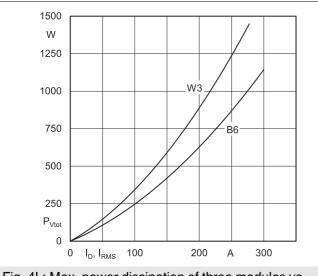




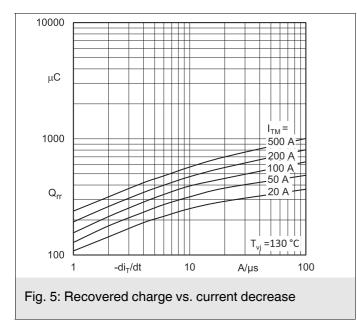


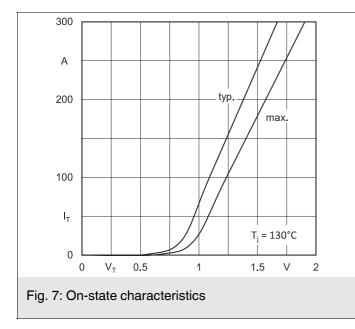


temperature









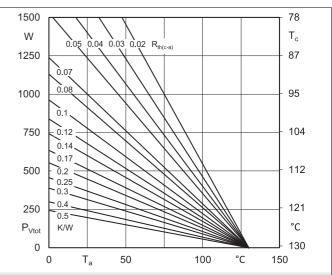


Fig. 4R: Max. power dissipation of three modules vs. case temperature

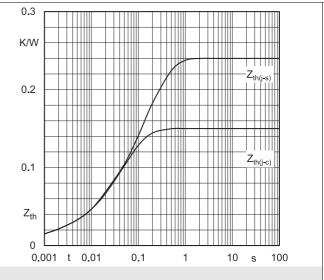
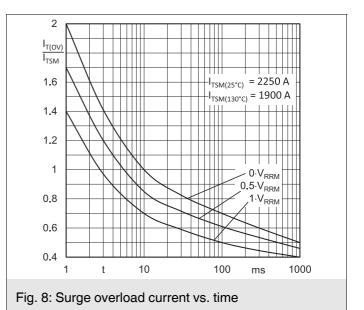
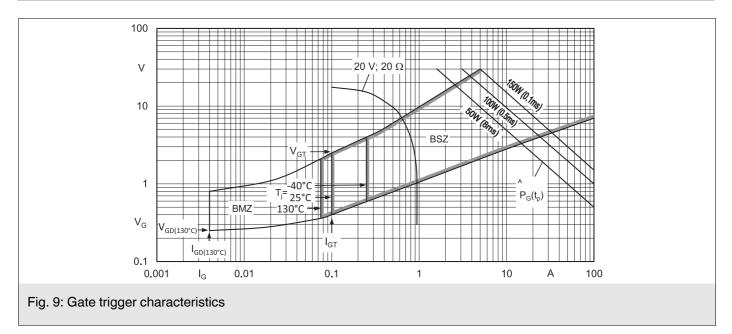
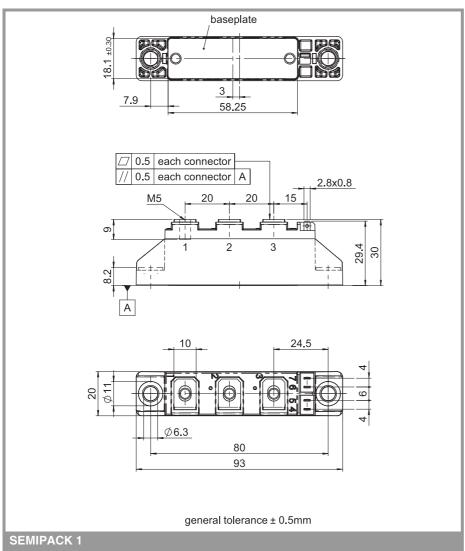


Fig. 6: Transient thermal impedance vs. time



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This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

#### **\*IMPORTANT INFORMATION AND WARNINGS**

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